

Electronic Patent Application Fee Transmittal

Application Number:	10038264
Filing Date:	03-Jan-2002
Title of Invention:	Solder interconnect techniques
First Named Inventor:	Seungbae Park
Filer:	George McGuire/Ann Miller
Attorney Docket Number:	EN999048D

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 1 month with \$0 paid	1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				120